

# $\mu$ PD46365092B $\mu$ PD46365182B $\mu$ PD46365362B

## 36M-BIT QDR<sup>™</sup> II SRAM 2-WORD BURST OPERATION

R10DS0089EJ0400 Rev.4.00 Nov 09, 2012

### **Description**

The  $\mu$ PD46365092B is a 4,194,304-word by 9-bit, the  $\mu$ PD46365182B is a 2,097,152-word by 18-bit and the  $\mu$ PD46365362B is a 1,048,576-word by 36-bit synchronous quad data rate static RAM fabricated with advanced CMOS technology using full CMOS six-transistor memory cell.

The  $\mu$ PD46365092B,  $\mu$ PD46365182B and  $\mu$ PD46365362B integrate unique synchronous peripheral circuitry and a burst counter. All input registers controlled by an input clock pair (K and K#) are latched on the positive edge of K and K#.

These products are suitable for application which require synchronous operation, high speed, low voltage, high density and wide bit configuration. These products are packaged in 165-pin PLASTIC BGA.

#### **Features**

- $1.8 \pm 0.1$  V power supply
- 165-pin PLASTIC BGA (13 x 15)
- HSTL interface
- PLL circuitry for wide output data valid window and future frequency scaling
- Separate independent read and write data ports with concurrent transactions
- 100% bus utilization DDR READ and WRITE operation
- Two-tick burst for low DDR transaction size
- Two input clocks (K and K#) for precise DDR timing at clock rising edges only
- Two output clocks (C and C#) for precise flight time and clock skew matching-clock and data delivered together to receiving device
- Internally self-timed write control
- Clock-stop capability. Normal operation is restored in 20  $\mu$ s after clock is resumed.
- User programmable impedance output (35 to 70  $\Omega$ )
- Fast clock cycle time: 3.3 ns (300 MHz), 4.0 ns (250 MHz).
- Simple control logic for easy depth expansion
- JTAG 1149.1 compatible test access port

## **Ordering Information**

Part No.	Organization (word x bit)	Cycle time	Clock frequency	Core Supply Voltage	Operating Ambient Temperature	Package
PD46365092BF1-E33-EQ1-A	4M x 9	3.3ns	300MHz	1.8 ± 0.1V	T <sub>A</sub> = 0 to 70°C	165-pin
PD46365092BF1-E40-EQ1-A		4.0ns	250MHz	]		PLASTIC
PD46365182BF1-E33-EQ1-A	2M x 18	3.3ns	300MHz	]		BGA
PD46365182BF1-E40-EQ1-A		4.0ns	250MHz			(13 x 15)
PD46365362BF1-E33-EQ1-A	1M x 36	3.3ns	300MHz	]		Lead-free
PD46365362BF1-E40-EQ1-A		4.0ns	250MHz	]		
PD46365092BF1-E33Y-EQ1-A	4M x 9	3.3ns	300MHz	1.8 ± 0.1V	T <sub>A</sub> = -40 to 85°C	
PD46365092BF1-E40Y-EQ1-A		4.0ns	250MHz	]		
PD46365182BF1-E33Y-EQ1-A	2M x 18	3.3ns	300MHz	]		
PD46365182BF1-E40Y-EQ1-A		4.0ns	250MHz			
PD46365362BF1-E33Y-EQ1-A	1M x 36	3.3ns	300MHz			
PD46365362BF1-E40Y-EQ1-A		4.0ns	250MHz			
PD46365092BF1-E33-EQ1	4M x 9	3.3ns	300MHz	1.8 ± 0.1V	T <sub>A</sub> = 0 to 70°C	165-pin
PD46365092BF1-E40-EQ1		4.0ns	250MHz			PLASTIC
PD46365182BF1-E33-EQ1	2M x 18	3.3ns	300MHz			BGA
PD46365182BF1-E40-EQ1		4.0ns	250MHz			(13 x 15)
PD46365362BF1-E33-EQ1	1M x 36	3.3ns	300MHz			Lead
PD46365362BF1-E40-EQ1		4.0ns	250MHz			
PD46365092BF1-E33Y-EQ1	4M x 9	3.3ns	300MHz	1.8 ± 0.1V	T <sub>A</sub> = -40 to 85°C	
PD46365092BF1-E40Y-EQ1		4.0ns	250MHz			
PD46365182BF1-E33Y-EQ1	2M x 18	3.3ns	300MHz			
PD46365182BF1-E40Y-EQ1		4.0ns	250MHz			
PD46365362BF1-E33Y-EQ1	1M x 36	3.3ns	300MHz			
PD46365362BF1-E40Y-EQ1		4.0ns	250MHz			

## **Pin Arrangement**

#### 165-pin PLASTIC BGA (13 x 15)

(Top View)

[*µ*PD46365092B]

4M x 9

	1	2	3	4	5	6	7	8	9	10	11
Α	CQ#	Vss/72M	Α	W#	NC	K#	NC/144M	R#	Α	Α	CQ
В	NC	NC	NC	Α	NC/288M	K	BW0#	Α	NC	NC	Q4
С	NC	NC	NC	<b>V</b> ss	Α	Α	Α	Vss	NC	NC	D4
D	NC	D5	NC	<b>V</b> ss	Vss	Vss	Vss	Vss	NC	NC	NC
Ε	NC	NC	Q5	VDDQ	<b>V</b> ss	Vss	<b>V</b> ss	$V_{DD}Q$	NC	D3	Q3
F	NC	NC	NC	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	$V_{DD}Q$	NC	NC	NC
G	NC	D6	Q6	$V_{DD}Q$	<b>V</b> DD	Vss	<b>V</b> DD	$V_{DD}Q$	NC	NC	NC
н	DLL#	VREF	$V_{DD}Q$	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	VDDQ	VREF	ZQ
J	NC	NC	NC	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	NC	Q2	D2
ĸ	NC	NC	NC	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	NC	NC	NC
L	NC	Q7	D7	VDDQ	Vss	Vss	Vss	VDDQ	NC	NC	Q1
М	NC	NC	NC	Vss	Vss	Vss	Vss	Vss	NC	NC	D1
N	NC	D8	NC	Vss	Α	Α	Α	Vss	NC	NC	NC
Р	NC	NC	Q8	Α	Α	С	Α	Α	NC	D0	Q0
R	TDO	тск	Α	Α	Α	C#	Α	Α	Α	TMS	TDI

A	: Address inputs	TMS	: IEEE 1149.1 Test input
D0 to D8	: Data inputs	TDI	: IEEE 1149.1 Test input
Q0 to Q8	: Data outputs	TCK	: IEEE 1149.1 Clock input
R#	: Read input	TDO	: IEEE 1149.1 Test output
W#	: Write input	$ m V_{REF}$	: HSTL input reference input
BW0#	: Byte Write data select	$ m V_{DD}$	: Power Supply

ZQ : Output impedance matching NC/xxM : Expansion address for xxMb

DLL# : PLL disable

**Remarks 1.** ×××# indicates active LOW.

2. Refer to Package Dimensions for the index mark.

**3.** 2A, 7A and 5B are expansion addresses : 2A for 72Mb

: 2A and 7A for 144Mb

: 2A, 7A and 5B for 288Mb

2A of this product can also be used as NC.

## **Pin Arrangement**

#### 165-pin PLASTIC BGA (13 x 15)

(Top View)

[*µ*PD46365182B]

2M x 18

	1	2	3	4	5	6	7	8	9	10	11
Α	CQ#	Vss/144M	Α	W#	BW1#	K#	NC/288M	R#	Α	Vss/72M	CQ
В	NC	Q9	D9	Α	NC	K	BW0#	Α	NC	NC	Q8
С	NC	NC	D10	Vss	Α	Α	Α	Vss	NC	Q7	D8
D	NC	D11	Q10	Vss	Vss	Vss	Vss	Vss	NC	NC	D7
Е	NC	NC	Q11	VDDQ	Vss	Vss	Vss	VDDQ	NC	D6	Q6
F	NC	Q12	D12	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	NC	NC	Q5
G	NC	D13	Q13	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	NC	NC	D5
н	DLL#	VREF	VDDQ	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	VDDQ	VREF	ZQ
J	NC	NC	D14	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	NC	Q4	D4
κ	NC	NC	Q14	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	NC	D3	Q3
L	NC	Q15	D15	VDDQ	Vss	Vss	Vss	VDDQ	NC	NC	Q2
М	NC	NC	D16	Vss	Vss	Vss	Vss	Vss	NC	Q1	D2
N	NC	D17	Q16	Vss	Α	Α	Α	Vss	NC	NC	D1
Р	NC	NC	Q17	Α	Α	С	Α	Α	NC	D0	Q0
R	TDO	тск	Α	Α	Α	C#	Α	Α	Α	TMS	TDI

Α : Address inputs **TMS** : IEEE 1149.1 Test input D0 to D17 : Data inputs TDI : IEEE 1149.1 Test input Q0 to Q17 TCK : IEEE 1149.1 Clock input : Data outputs TDO R# : Read input : IEEE 1149.1 Test output W# : Write input  $V_{\text{REF}}$ : HSTL input reference input

BW0#, BW1# : Byte Write data select  $V_{DD}$ : Power Supply K, K# : Input clock  $V_{DD}Q$ : Power Supply C, C# : Output clock : Ground  $V_{SS}$ CQ, CQ# : Echo clock NC : No connection

ZQ : Output impedance matching NC/xxM : Expansion address for xxMb

DLL# : PLL disable

#### **Remarks 1.** ×××# indicates active LOW.

2. Refer to Package Dimensions for the index mark.

**3.** 2A, 7A and 10A are expansion addresses : 10A for 72Mb

: 10A and 2A for 144Mb

: 10A, 2A and 7A for 288Mb

2A and 10A of this product can also be used as NC.

## **Pin Arrangement**

#### 165-pin PLASTIC BGA (13 x 15)

(Top View)

[*µ*PD46365362B]

1M x 36

	1	2	3	4	5	6	7	8	9	10	11
Α	CQ#	Vss/288M	NC/72M	W#	BW2#	K#	BW1#	R#	Α	Vss/144M	CQ
В	Q27	Q18	D18	Α	BW3#	K	BW0#	Α	D17	Q17	Q8
С	D27	Q28	D19	Vss	Α	Α	Α	Vss	D16	Q7	D8
D	D28	D20	Q19	Vss	Vss	Vss	Vss	Vss	Q16	D15	D7
Е	Q29	D29	Q20	VDDQ	Vss	Vss	Vss	VDDQ	Q15	D6	Q6
F	Q30	Q21	D21	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	D14	Q14	Q5
G	D30	D22	Q22	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	Q13	D13	D5
н	DLL#	VREF	VDDQ	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	VDDQ	VREF	ZQ
J	D31	Q31	D23	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	D12	Q4	D4
κ	Q32	D32	Q23	VDDQ	<b>V</b> DD	Vss	<b>V</b> DD	VDDQ	Q12	D3	Q3
L	Q33	Q24	D24	VDDQ	Vss	Vss	Vss	VDDQ	D11	Q11	Q2
М	D33	Q34	D25	Vss	Vss	Vss	Vss	Vss	D10	Q1	D2
N	D34	D26	Q25	Vss	Α	Α	Α	Vss	Q10	D9	D1
Р	Q35	D35	Q26	Α	Α	С	Α	Α	Q9	D0	Q0
R	TDO	тск	Α	Α	Α	C#	Α	Α	Α	TMS	TDI

Α : Address inputs **TMS** : IEEE 1149.1 Test input D0 to D35 : Data inputs TDI : IEEE 1149.1 Test input Q0 to Q35 TCK : Data outputs : IEEE 1149.1 Clock input TDO R# : Read input : IEEE 1149.1 Test output W# : Write input  $V_{\text{REF}}$ : HSTL input reference input

BW0# to BW3# : Byte Write data select  $V_{DD}$ : Power Supply K, K# : Input clock  $V_{DD}Q$ : Power Supply C, C# : Output clock : Ground  $V_{SS}$ CQ, CQ# : Echo clock NC : No connection

ZQ : Output impedance matching NC/xxM : Expansion address for xxMb

DLL# : PLL disable

**Remarks 1.** ×××# indicates active LOW.

2. Refer to Package Dimensions for the index mark.

**3.** 2A, 3A and 10A are expansion addresses : 3A for 72Mb

: 3A and 10A for 144Mb

: 3A, 10A and 2A for 288Mb

2A and 10A of this product can also be used as NC.

## **Pin Description**

(1/2)

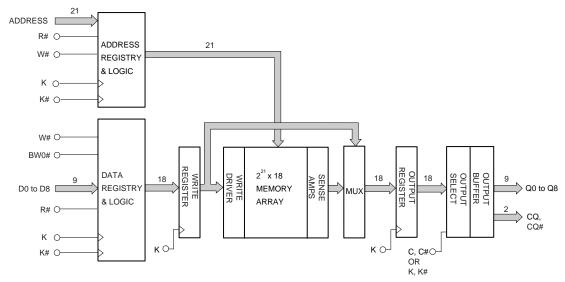
Symbol	Туре	Description
A	Input	Synchronous Address Inputs: These inputs are registered and must meet the setup and hold times around the rising edge of K for READ cycles and must meet the setup and hold times around the rising edge of K# for WRITE cycles. All transactions operate on a burst of two words (one clock period of bus activity). These inputs are ignored when device is deselected, i.e., NOP (R# = W# = HIGH).
D0 to Dxx	Input	Synchronous Data Inputs: Input data must meet setup and hold times around the rising edges of K and K# during WRITE operations. See <b>Pin Arrangement</b> for ball site location of individual signals.  x9 device uses D0 to D8.  x18 device uses D0 to D17.  x36 device uses D0 to D35.
Q0 to Qxx	Output	Synchronous Data Outputs: Output data is synchronized to the respective C and C# or to K and K# rising edges if C and C# are tied HIGH. Data is output in synchronization with C and C# (or K and K#), depending on the R# command. See <b>Pin Arrangement</b> for ball site location of individual signals.  x9 device uses Q0 to Q8.  x18 device uses Q0 to Q17.  x36 device uses Q0 to Q35.
R#	Input	Synchronous Read: When LOW this input causes the address inputs to be registered and a READ cycle to be initiated. This input must meet setup and hold times around the rising edge of K.
W#	Input	Synchronous Write: When LOW this input causes the address inputs to be registered and a WRITE cycle to be initiated. This input must meet setup and hold times around the rising edge of K.
BWx#	Input	Synchronous Byte Writes: When LOW these inputs cause their respective byte to be registered and written during WRITE cycles. These signals must meet setup and hold times around the rising edges of K and K# for each of the two rising edges comprising the WRITE cycle. See <b>Pin Arrangement</b> for signal to data relationships.  x9 device uses BW0#.  x18 device uses BW0#, BW1#.  x36 device uses BW0# to BW3#.  See <b>Byte Write Operation</b> for relation between BWx# and Dxx.
K, K#	Input	Input Clock: A READ address and control input signal are input in synchronization with the rising edge of K and a WRITE address is input in synchronization with the rising edge of K#. Input data is input in synchronization with the rising edge of K and K#. K# is ideally 180 degrees out of phase with K. All synchronous inputs must meet setup and hold times around the clock rising edges.
C, C#	Input	Output Clock: This clock pair provides a user controlled means of tuning device output data. The rising edge of C# is used as the output timing reference for first output data. The rising edge of C is used as the output reference for second output data. Ideally, C# is 180 degrees out of phase with C. When use of K and K# as the reference instead of C and C#, then fixed C and C# to HIGH. Operation cannot be guaranteed unless C and C# are fixed to HIGH (i.e. toggle of C and C#).

(2/2)

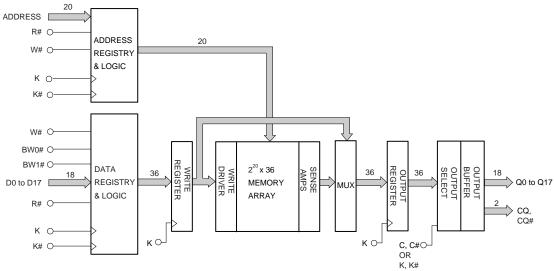
Symbol	Туре	Description
CQ, CQ#	Output	Synchronous Echo Clock Outputs. The rising edges of these outputs are tightly matched to the synchronous data outputs and can be used as a data valid indication. These signals run freely and do not stop when Q tristates. If C and C# are stopped (if K and K# are stopped in the single clock mode), CQ and CQ# will also stop.
ZQ	Input	Output Impedance Matching Input: This input is used to tune the device outputs to the system data bus impedance. Q, CQ and CQ# output impedance are set to 0.2 x RQ, where RQ is a resistor from this bump to ground. The output impedance can be minimized by directly connect ZQ to VDDQ. This pin cannot be connected directly to GND or left unconnected. The output impedance is adjusted every 20 $\mu$ s upon power-up to account for drifts in supply voltage and temperature. After replacement for a resistor, the new output impedance is reset by implementing power-on sequence.
DLL#	Input	PLL Disable: When debugging the system or board, the operation can be performed at a clock frequency slower than TKHKH (MAX.) without the PLL circuit being used, if DLL# = LOW. The AC/DC characteristics cannot be guaranteed. For normal operation, DLL# must be HIGH and it can be connected to $V_{DD}Q$ through a 10 k $\Omega$ or less resistor.
TMS TDI	Input	IEEE 1149.1 Test Inputs: 1.8 V I/O level. These balls may be left Not Connected if the JTAG function is not used in the circuit.
TCK	Input	IEEE 1149.1 Clock Input: 1.8 V I/O level. This pin must be tied to Vss if the JTAG function is not used in the circuit.
TDO	Output	IEEE 1149.1 Test Output: 1.8 V I/O level. When providing any external voltage to TDO signal, it is recommended to pull up to VDD.
VREF	-	HSTL Input Reference Voltage: Nominally VDDQ/2. Provides a reference voltage for the input buffers.
V <sub>DD</sub>	Supply	Power Supply: 1.8 V nominal. See <b>Recommended DC Operating Conditions</b> and <b>DC Characteristics</b> for range.
VddQ	Supply	Power Supply: Isolated Output Buffer Supply. Nominally 1.5 V. 1.8 V is also permissible. See <b>Recommended DC Operating Conditions</b> and <b>DC Characteristics</b> for range.
Vss	Supply	Power Supply: Ground
NC	_	No Connect: These signals are not connected internally.

## **Block Diagram**

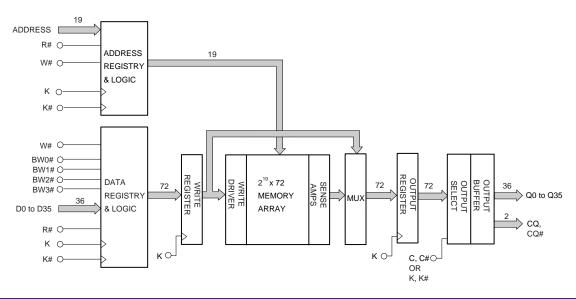
#### [µPD46365092B]



#### [µPD46365182B]



## [µPD46365362B]



### **Power-On Sequence in QDR II SRAM**

QDR II SRAMs must be powered up and initialized in a predefined manner to prevent undefined operations.

The following timing charts show the recommended power-on sequence.

The following power-up supply voltage application is recommended: Vss, Vdd, VddQ, VREF, then VIN. Vdd and VddQ can be applied simultaneously, as long as VddQ does not exceed Vdd by more than 0.5 V during power-up. The following power-down supply voltage removal sequence is recommended: VIN, VREF, VddQ, Vdd, Vss. Vdd and VddQ can be removed simultaneously, as long as VddQ does not exceed Vdd by more than 0.5 V during power-down.

#### **Power-On Sequence**

Apply power and tie DLL# to HIGH.

Apply  $V_{DD}Q$  before  $V_{REF}$  or at the same time as  $V_{REF}$ .

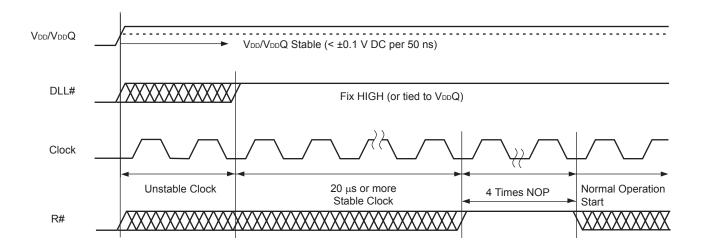
Provide stable clock for more than 20  $\mu$ s to lock the PLL.

Continuous min.4 NOP(R# = high) cycles are required after PLL lock up is done.

#### **PLL Constraints**

The PLL uses K clock as its synchronizing input and the input should have low phase jitter which is specified as TKC var. The PLL can cover 120 MHz as the lowest frequency. If the input clock is unstable and the PLL is enabled, then the PLL may lock onto an undesired clock frequency.

#### **Power-On Waveforms**



#### **Truth Table**

Operation	CLK	R#	W#	D or Q			
WRITE cycle	$L\to H$	×	L	Data in			
Load address, input write data on				Input data DA (A+0) DA (A+1)			
consecutive K and K# rising edge				Input clock K(t)↑ K#(t)↑			
READ cycle	$L \rightarrow H$	L	×	Data out			
Load address, output data on				Output data QA (A+0) QA (A+1)			
consecutive C and C# rising edge				Output clock C#(t+1) ↑ C(t+2) ↑			
NOP (No operation)	$L \rightarrow H$	Н	Н	$D = \times$ , $Q = High-Z$			
Clock stop	Stopped	×	×	Previous state			

**Remarks 1.** H: HIGH, L: LOW, ×: don't care, ↑: rising edge.

- 2. Data inputs are registered at K and K# rising edges. Data outputs are delivered at C and C# rising edges except if C and C# are HIGH then Data outputs are delivered at K and K# rising edges.
- **3.** All control inputs in the truth table must meet setup/hold times around the rising edge (LOW to HIGH) of K. All control inputs are registered during the rising edge of K.
- 4. This device contains circuitry that ensure the outputs to be in high impedance during power-up.
- **5.** Refer to state diagram and timing diagrams for clarification.
- **6.** It is recommended that K = K# = C = C# when clock is stopped. This is not essential but permits most rapid restart by overcoming transmission line charging symmetrically.

## **Byte Write Operation**

#### [*µ*PD46365092B]

Operation	K	K#	BW0#
Write D0 to D8	$L \rightarrow H$	-	0
	_	$L \rightarrow H$	0
Write nothing	$L \rightarrow H$	_	1
	_	$L \rightarrow H$	1

**Remarks 1.** H: HIGH, L: LOW,  $\rightarrow$ : rising edge.

2. Assumes a WRITE cycle was initiated. BW0# can be altered for any portion of the BURST WRITE operation provided that the setup and hold requirements are satisfied.

#### [µPD46365182B]

Operation	K	K#	BW0#	BW1#
Write D0 to D17	$L \rightarrow H$	_	0	0
	_	$L \rightarrow H$	0	0
Write D0 to D8	$L \rightarrow H$	_	0	1
	_	$L \rightarrow H$	0	1
Write D9 to D17	$L \rightarrow H$	_	1	0
	_	$L \rightarrow H$	1	0
Write nothing	$L \rightarrow H$	_	1	1
	_	$L \rightarrow H$	1	1

**Remarks 1.** H: HIGH, L: LOW,  $\rightarrow$ : rising edge.

2. Assumes a WRITE cycle was initiated. BW0# and BW1# can be altered for any portion of the BURST WRITE operation provided that the setup and hold requirements are satisfied.

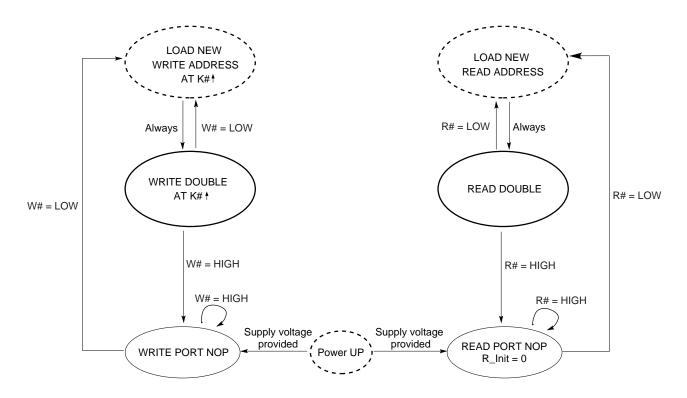
#### [µPD46365362B]

Operation	K	K#	BW0#	BW1#	BW2#	BW3#
Write D0 to D35	$L \rightarrow H$	-	0	0	0	0
	_	$L \rightarrow H$	0	0	0	0
Write D0 to D8	$L \rightarrow H$	_	0	1	1	1
	_	$L \rightarrow H$	0	1	1	1
Write D9 to D17	$L \rightarrow H$	_	1	0	1	1
	_	$L \rightarrow H$	1	0	1	1
Write D18 to D26	$L \rightarrow H$	_	1	1	0	1
	_	$L \rightarrow H$	1	1	0	1
Write D27 to D35	$L \rightarrow H$	_	1	1	1	0
	_	$L \rightarrow H$	1	1	1	0
Write nothing	$L\toH$	_	1	1	1	1
	_	$L\toH$	1	1	1	1

**Remarks 1.** H: HIGH, L: LOW,  $\rightarrow$ : rising edge.

**2.** Assumes a WRITE cycle was initiated. BW0# to BW3# can be altered for any portion of the BURST WRITE operation provided that the setup and hold requirements are satisfied.

## **Bus Cycle State Diagram**



**Remarks 1.** The address is concatenated with 1 additional internal LSB to facilitate burst operation.

The address order is always fixed as: xxx...xxx+0, xxx...xxx+1.

Bus cycle is terminated at the end of this sequence (burst count = 2).

- 2. Read and write state machines can be active simultaneously.
- 3. State machine control timing sequence is controlled by K.

#### **Electrical Characteristics**

#### **Absolute Maximum Ratings**

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage	$V_{DD}$		-0.5 to +2.5	V
Output supply voltage	$V_{DD}Q$		−0.5 to V <sub>DD</sub>	V
Input voltage	V <sub>IN</sub>		-0.5 to V <sub>DD</sub> +0.5 (2.5 V MAX.)	V
Input / Output voltage	V <sub>I/O</sub>		-0.5 to V <sub>DD</sub> Q+0.5 (2.5 V MAX.)	٧
Operating ambient temperature	TA	(E** series)	0 to 70	°C
		(E**Y series)	-40 to 85	°C
Storage temperature	Tstg		-55 to +125	°C

Caution Exposing the device to stress above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

#### Recommended DC Operating Conditions ( $T_A = 0$ to $70^{\circ}$ C, $T_A = -40$ to $85^{\circ}$ C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	Note
Supply voltage	$V_{DD}$		1.7	1.8	1.9	V	
Output supply voltage	$V_{DD}Q$		1.4		$V_{DD}$	V	1
Input HIGH voltage	V <sub>IH (DC)</sub>		V <sub>REF</sub> +0.1		V <sub>DD</sub> Q+0.3	V	1, 2
Input LOW voltage	V <sub>IL (DC)</sub>		-0.3		V <sub>REF</sub> -0.1	V	1, 2
Clock input voltage	V <sub>IN</sub>		-0.3		V <sub>DD</sub> Q+0.3	V	1, 2
Reference voltage	$V_{REF}$		0.68		0.95	V	

Notes 1. During normal operation,  $V_{DD}Q$  must not exceed  $V_{DD}$ .

2. Power-up: VIH  $\leq$  V<sub>DD</sub>Q+0.3 V and V<sub>DD</sub>  $\leq$  1.7 V and V<sub>DD</sub>Q  $\leq$  1.4 V for t  $\leq$  200 ms

#### Recommended AC Operating Conditions ( $T_A = 0$ to $70^{\circ}$ C, $T_A = -40$ to $85^{\circ}$ C)

Parameter	Symbol	Conditions	MIN.	MAX.	Unit	Note
Input HIGH voltage	V <sub>IH (AC)</sub>		V <sub>REF</sub> +0.2		V	1
Input LOW voltage	V <sub>IL (AC)</sub>			V <sub>REF</sub> -0.2	V	1

**Note 1.** Overshoot:  $V_{IH (AC)} \le V_{DD} + 0.7 \text{ V } (2.5 \text{ V MAX.}) \text{ for } t \le TKHKH/2$ 

Undershoot:  $V_{IL (AC)} \ge -0.5 \text{ V}$  for  $t \le TKHKH/2$ 

Control input signals may not have pulse widths less than TKHKL (MIN.) or operate at cycle rates less than

TKHKH (MIN.).



## DC Characteristics 1 (T<sub>A</sub> = 0 to 70°C, $V_{DD}$ = 1.8 $\pm$ 0.1 V)

Parameter	Symbol	Test condition		MIN.		MAX.		Unit	Note
					х9	x18	x36		
Input leakage current	lu			-2		+2		μΑ	
I/O leakage current	lьо			-2		+2		μΑ	
Operating supply current	IDD	$V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH},$	-E33		570	690	770	mA	
(Read cycle / Write cycle)		I <sub>1</sub> /O = 0 mA,							
		Cycle = MAX.	-E40		510	610	690		
Standby supply current	I <sub>SB1</sub>	$V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH},$	-E33		310	320	340	mA	
(NOP)		I <sub>1</sub> /O = 0 mA,							
		Cycle = MAX.	-E40		300	310	330		
		Inputs static							
Output HIGH voltage	VoH(Low)	Ioн  ≤ 0.1 mA		V <sub>DD</sub> Q-0.2		$V_{DD}Q$		V	3,4
	Vон	Note1		V <sub>DD</sub> Q/2-0.12	V <sub>DI</sub>	Q/2+0	).12	٧	3,4
Output LOW voltage	VOL(Low)	IoL ≤ 0.1 mA		VSS	0.2		٧	3,4	
	Vol	Note2		V <sub>DD</sub> Q/2-0.12	V <sub>DI</sub>	<sub>0</sub> Q/2+0	).12	V	3,4

Notes 1. Outputs are impedance-controlled.  $|I_{OH}| = (V_{DD}Q/2)/(RQ/5) \pm 15\%$  for values of 175  $\Omega \le RQ \le 350 \ \Omega$ .

- 2. Outputs are impedance-controlled.  $I_{OL} = (V_{DD}Q/2)/(RQ/5) \pm 15\%$  for values of 175  $\Omega \le RQ \le 350 \ \Omega$ .
- **3.** AC load current is higher than the shown DC values.
- **4.** HSTL outputs meet JEDEC HSTL Class I standards.

## DC Characteristics 2 (T<sub>A</sub> = -40 to 85°C, $V_{DD}$ = 1.8 $\pm$ 0.1 V)

Parameter	Symbol	Test condition		MIN.		MAX.		Unit	Note
					x9	x18	x36		
Input leakage current	lu			-2		+2		μΑ	
I/O leakage current	llo			-2		+2		μΑ	
Operating supply current	IDD	$V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH},$	-E33Y		700	820	910	mA	
(Read cycle / Write cycle)		I <sub>1</sub> /O = 0 mA,							
		Cycle = MAX.	-E40Y		640	740	830		
Standby supply current	I <sub>SB1</sub>	$V_{IN} \le V_{IL} \text{ or } V_{IN} \ge V_{IH},$	-E33Y		430	440	470	mA	
(NOP)		I <sub>I/O</sub> = 0 mA,							
		Cycle = MAX.	-E40Y		420	430	460		
		Inputs static							
Output HIGH voltage	VoH(Low)	Ioн  ≤ 0.1 mA		V <sub>DD</sub> Q-0.2		$V_{DD}Q$		V	3,4
	Vон	Note1		V <sub>DD</sub> Q/2-0.12	V <sub>DI</sub>	Q/2+0	.12	٧	3,4
Output LOW voltage	VOL(Low)	IoL ≤ 0.1 mA		VSS	0.2		V	3,4	
	Vol	Note2		V <sub>DD</sub> Q/2-0.12	V <sub>DI</sub>	Q/2+0	).12	V	3,4

Notes 1. Outputs are impedance-controlled.  $|I_{OH}| = (V_{DD}Q/2)/(RQ/5) \pm 15\%$  for values of 175  $\Omega \le RQ \le 350 \ \Omega$ .

- 2. Outputs are impedance-controlled.  $I_{OL} = (V_{DD}Q/2)/(RQ/5) \pm 15\%$  for values of 175  $\Omega \le RQ \le 350 \ \Omega$ .
- **3.** AC load current is higher than the shown DC values.
- **4.** HSTL outputs meet JEDEC HSTL Class I standards.

## Capacitance ( $T_A = 25^{\circ}C$ , f = 1 MHz)

Parameter	Symbol	Test conditions	MIN.	MAX.	Unit
Input capacitance (Address, Control)	Cin	V <sub>IN</sub> = 0 V		5	pF
Input / Output capacitance	C <sub>I/O</sub>	V <sub>I/O</sub> = 0 V		7	pF
(D, Q, CQ, CQ#)					
Clock Input capacitance	Cclk	V <sub>clk</sub> = 0 V		6	pF

**Remark** These parameters are periodically sampled and not 100% tested.

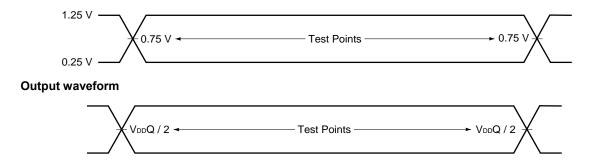
## **Thermal Characteristics**

Parameter	Symbol	Substrate	Airflow	TYP.	Unit
Thermal resistance	$\theta$ ja	4-layer	0 m/s	16.5	°C/W
from junction to ambient air			1 m/s	13.2	°C/W
		8-layer	0 m/s	15.5	°C/W
			1 m/s	12.6	°C/W
Thermal characterization parameter	Ψjt	4-layer	0 m/s	0.07	°C/W
from junction to the top center			1 m/s	0.13	°C/W
of the package surface		8-layer	0 m/s	0.06	°C/W
			1 m/s	0.12	°C/W
Thermal resistance	$\theta$ jc			3.86	°C/W
from junction to case					

AC Characteristics ( $T_A = 0$  to  $70^{\circ}$ C,  $T_A = -40$  to  $85^{\circ}$ C,  $V_{DD} = 1.8 \pm 0.1 \text{ V}$ )

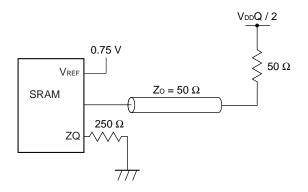
AC Test Conditions (VDD = 1.8  $\pm$  0.1 V, VDDQ = 1.4 V to VDD)

Input waveform (Rise / Fall time ≤ 0.3 ns)



#### **Output load condition**

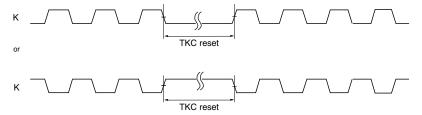
Figure 1. External load at test



## **Read and Write Cycle**

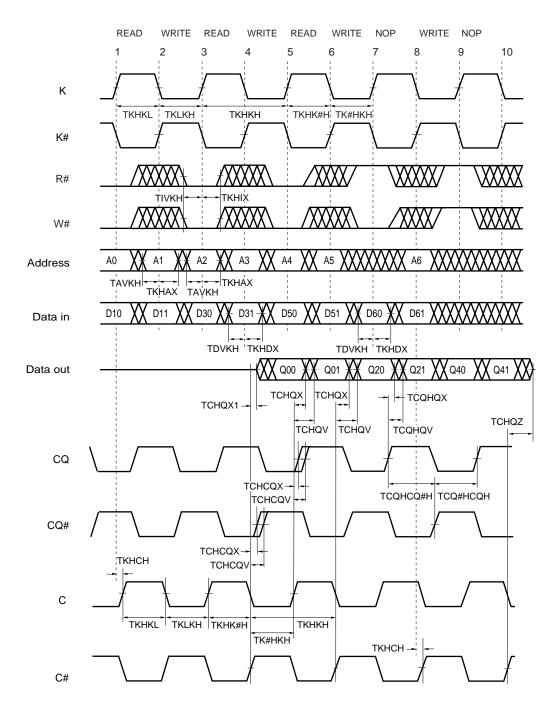
Parameter	Symbol		-E33Y MHz)		-E40Y MHz)	Unit	Note
		MIN.	MAX.	MIN.	MAX.		
Clock				<u> </u>	1		1
Average Clock cycle time (K, K#, C, C#)	TKHKH	3.3	8.4	4.0	8.4	ns	1
Clock phase jitter (K, K#, C, C#)	TKC var		0.2		0.2	ns	2
Clock HIGH time (K, K#, C, C#)	TKHKL	1.32		1.6		ns	
Clock LOW time (K, K#, C, C#)	TKLKH	1.32		1.6		ns	
Clock HIGH to Clock# HIGH $(K \rightarrow K\#, C \rightarrow C\#)$	TKHK#H	1.49		1.8		ns	
Clock# HIGH to Clock HIGH (K# $\rightarrow$ K, C# $\rightarrow$ C)	TK#HKH	1.49		1.8		ns	
Clock to data clock $(K \rightarrow C, K\# \rightarrow C\#)$	TKHCH	0	1.45	0	1.8	ns	
PLL lock time (K, C)	TKC lock	20		20		μS	3
K static to PLL reset	TKC reset	30		30		ns	4
			JI.	•		ч	
Output Times							
CQ HIGH to CQ# HIGH	TCQHCQ#H	1.24		1.55		ns	5
$(CQ \rightarrow CQ\#)$							
CQ# HIGH to CQ HIGH (CQ# $\rightarrow$ CQ)	TCQ#HCQH	1.24		1.55		ns	5
C, C# HIGH to output valid	TCHQV		0.45		0.45	ns	
C, C# HIGH to output hold	TCHQX	-0.45		-0.45		ns	
C, C# HIGH to echo clock valid	TCHCQV		0.45		0.45	ns	
C, C# HIGH to echo clock hold	TCHCQX	-0.45		-0.45		ns	
CQ, CQ# HIGH to output valid	TCQHQV		0.27		0.3	ns	6
CQ, CQ# HIGH to output hold	TCQHQX	-0.27		-0.3		ns	6
C HIGH to output High-Z	TCHQZ		0.45		0.45	ns	
C HIGH to output Low-Z	TCHQX1	-0.45		-0.45		ns	
	_						
Setup Times							
Address valid to K rising edge	TAVKH	0.3		0.35		ns	7
Control inputs (R#, W#) valid to K rising edge	TIVKH	0.3		0.35		ns	7
Data inputs and write data select	TDVKH	0.3		0.35		ns	7
inputs (BWx#) valid to K, K# rising edge							
	•						
Hold Times			1	1		1	
K rising edge to address hold	TKHAX	0.3		0.35		ns	7
K rising edge to control inputs (R#, W#) hold	TKHIX	0.3		0.35		ns	7
K, K# rising edge to data inputs and write data select inputs (BWx#) hold	TKHDX	0.3		0.35		ns	7

- **Notes 1.** When debugging the system or board, these products can operate at a clock frequency slower than TKHKH (MAX.) without the PLL circuit being used, if DLL# = LOW. Read latency (RL) is changed to 1.0 clock cycle in this operation. The AC/DC characteristics cannot be guaranteed, however.
  - 2. Clock phase jitter is the variance from clock rising edge to the next expected clock rising edge. TKC var (MAX.) indicates a peak-to-peak value.
  - **3.** V<sub>DD</sub> slew rate must be less than 0.1 V DC per 50 ns for PLL lock retention.
    - PLL lock time begins once V<sub>DD</sub> and input clock are stable.
    - It is recommended that the device is kept NOP (R# = W# = HIGH) during these cycles.
  - **4.** K input is monitored for this operation. See below for the timing.



- 5. Guaranteed by design.
- **6.** Echo clock is very tightly controlled to data valid / data hold. By design, there is a  $\pm$  0.1 ns variation from echo clock to data. The data sheet parameters reflect tester guardbands and test setup variations.
- 7. This is a synchronous device. All addresses, data and control lines must meet the specified setup and hold times for all latching clock edges.
- **Remarks 1.** This parameter is sampled.
  - 2. Test conditions as specified with the output loading as shown in AC Test Conditions unless otherwise noted
  - 3. Control input signals may not be operated with pulse widths less than TKHKL (MIN.).
  - **4.** If C, C# are tied HIGH, K, K# become the references for C, C# timing parameters.
  - **5.** V<sub>DD</sub>Q is 1.5 V DC.

## **Read and Write Timing**



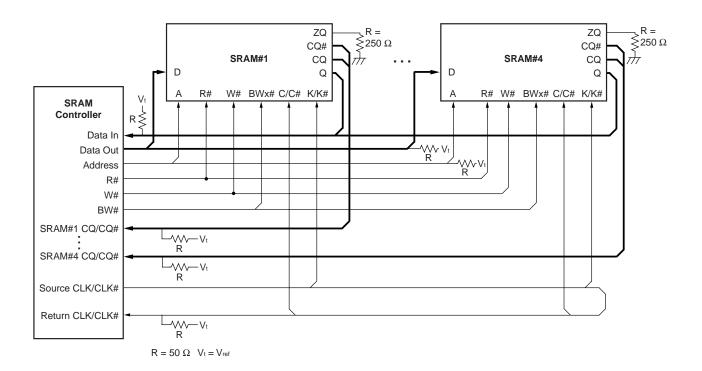
**Remarks 1.** Q00 refers to output from address A0+0.

Q01 refers to output from the next internal burst address following A0,i.e.,A0+1.

- 2. Outputs are disabled (high impedance) 2.5 clock cycles after the last READ (R# = LOW) is input in the sequences of [READ/WRITE]-[NOP/WRITE], [READ/WRITE]-[NOP/NOP], [READ/NOP]-[NOP/WRITE] and [READ/NOP] -[NOP/NOP].
- 3. In this example, if address A0 = A1, data Q00 = D10, Q01 = D11.

Write data is forwarded immediately as read results.

#### **Application Example**



Remark AC Characteristics are defined at the condition of SRAM outputs, CQ, CQ# and Q with termination.

## **JTAG Specification**

These products support a limited set of JTAG functions as in IEEE standard 1149.1.

**Test Access Port (TAP) Pins** 

Pin name	Pin assignments	Description
TCK	2R	Test Clock Input. All input are captured on the rising edge of TCK and all outputs propagate from the falling edge of TCK.
TMS	10R	Test Mode Select. This is the command input for the TAP controller state machine.
TDI	11R	Test Data Input. This is the input side of the serial registers placed between TDI and TDO. The register placed between TDI and TDO is determined by the state of the TAP controller state machine and the instruction that is currently loaded in the TAP instruction.
TDO	1R	Test Data Output. This is the output side of the serial registers placed between TDI and TDO. Output changes in response to the falling edge of TCK.

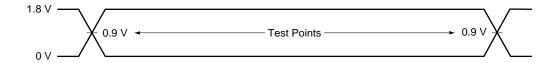
**Remark** The device does not have TRST (TAP reset). The Test-Logic Reset state is entered while TMS is held HIGH for five rising edges of TCK. The TAP controller state is also reset on the SRAM POWER-UP.

JTAG DC Characteristics (T<sub>A</sub> = 0 to 70°C,  $V_{DD}$  = 1.8  $\pm$  0.1 V, unless otherwise noted)

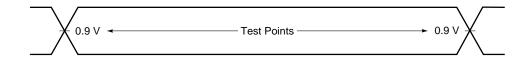
Parameter	Symbol	Conditions	MIN.	MAX.	Unit
JTAG Input leakage current	ILI	$0 \text{ V} \leq V_{IN} \leq V_{DD}$	-5.0	+5.0	μΑ
JTAG I/O leakage current	I <sub>LO</sub>	$0\ V \leq V_{IN} \leq V_{DD}Q,$	-5.0	+5.0	μΑ
		Outputs disabled			
JTAG input HIGH voltage	$V_{IH}$		1.3	V <sub>DD</sub> +0.3	V
JTAG input LOW voltage	$V_{IL}$		-0.3	+0.5	V
JTAG output HIGH voltage	$V_{\text{OH1}}$	I <sub>OHC</sub>   = 100 μA	1.6		٧
	$V_{\text{OH2}}$	I <sub>OHT</sub>   = 2 mA	1.4		V
JTAG output LOW voltage	V <sub>OL1</sub>	I <sub>OLC</sub> = 100 μA		0.2	V
	$V_{OL2}$	I <sub>OLT</sub> = 2 mA		0.4	V

#### **JTAG AC Test Conditions**

## Input waveform (Rise / Fall time ≤ 1 ns)

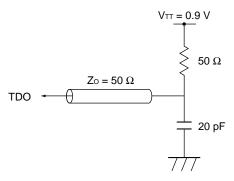


#### **Output waveform**



## **Output load**

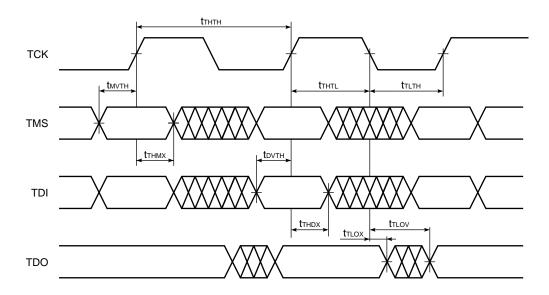
Figure 2. External load at test



JTAG AC Characteristics (T<sub>A</sub> = 0 to 70°C)

Parameter	Symbol	Conditions	MIN.	MAX.	Unit
Clock	•				•
Clock cycle time	tтнтн		50		ns
Clock frequency	f <sub>TF</sub>			20	MHz
Clock HIGH time	t <sub>THTL</sub>		20		ns
Clock LOW time	tтьтн		20		ns
Output time					
TCK LOW to TDO unknown	$t_{TLOX}$		0		ns
TCK LOW to TDO valid	t <sub>TLOV</sub>			10	ns
Setup time					
TMS setup time	t <sub>MVTH</sub>		5		ns
TDI valid to TCK HIGH	t <sub>DVTH</sub>		5		ns
Capture setup time	t <sub>CS</sub>		5		ns
Hold time					
TMS hold time	t <sub>THMX</sub>		5		ns
TCK HIGH to TDI invalid	t <sub>THDX</sub>		5		ns
Capture hold time	t <sub>CH</sub>		5		ns

## **JTAG Timing Diagram**



## Scan Register Definition (1)

Register name	Description
Instruction register	The instruction register holds the instructions that are executed by the TAP controller when it is moved into the run-test/idle or the various data register state. The register can be loaded when it is placed between the TDI and TDO pins. The instruction register is automatically preloaded with the IDCODE instruction at power-up whenever the controller is placed in test-logic-reset state.
Bypass register	The bypass register is a single bit register that can be placed between TDI and TDO. It allows serial test data to be passed through the RAMs TAP to another device in the scan chain with as little delay as possible.
ID register	The ID Register is a 32 bit register that is loaded with a device and vendor specific 32 bit code when the controller is put in capture-DR state with the IDCODE command loaded in the instruction register. The register is then placed between the TDI and TDO pins when the controller is moved into shift-DR state.
Boundary register	The boundary register, under the control of the TAP controller, is loaded with the contents of the RAMs I/O ring when the controller is in capture-DR state and then is placed between the TDI and TDO pins when the controller is moved to shift-DR state. Several TAP instructions can be used to activate the boundary register.  The Scan Exit Order tables describe which device bump connects to each boundary register location. The first column defines the bit's position in the boundary register. The second column is the name of the input or I/O at the bump and the third column is the bump number.

## Scan Register Definition (2)

Register name	Bit size	Unit
Instruction register	3	bit
Bypass register	1	bit
ID register	32	bit
Boundary register	109	bit

## **ID Register Definition**

Part number	Organization	ID [31:28] vendor revision no.	ID [27:12] part no.	ID [11:1] vendor ID no.	ID [0] fix bit
μPD46365092B	4M x 9	XXXX	0000 0000 0100 1010	00000010000	1
μPD46365182B	2M x 18	XXXX	0000 0000 0100 1011	00000010000	1
μPD46365362B	1M x 36	XXXX	0000 0000 0100 1100	00000010000	1

#### **SCAN Exit Order**

Bit	Signal name			Bump
no.	x9 x18 x36		ID	
1		C#		6R
2		С		6P
3	A			6N
4		Α		7P
5	A			7N
6	А			7R
7		Α		8R
8		Α		8P
9		Α		9R
10		Q0		11P
11		D0		10P
12	NC	NC	D9	10N
13	NC	NC	Q9	9P
14	NC	Q1	Q1	10M
15	NC	D1	D1	11N
16	NC	NC	D10	9M
17	NC	NC	Q10	9N
18	Q1	Q2	Q2	11L
19	D1	D2	D2	11M
20	NC	NC	D11	9L
21	NC	NC	Q11	10L
22	NC	Q3	Q3	11K
23	NC	D3	D3	10K
24	NC	NC	D12	9J
25	NC	NC	Q12	9K
26	Q2	Q4	Q4	10J
27	D2	D4	D4	11J
28		ZQ		11H
29	NC	NC	D13	10G
30	NC	NC	Q13	9G
31	NC	Q5	Q5	11F
32	NC	D5	D5	11G
33	NC	NC	D14	9F
34	NC	NC	Q14	10F
35	Q3	Q6	Q6	11E
36	D3	D6	D6	10E

Bit	Signal name		Bump	
no.	x9	x18	x36	ID
37	NC	NC	D15	10D
38	NC	NC	Q15	9E
39	NC	Q7	Q7	10C
40	NC	D7	D7	11D
41	NC	NC	D16	9C
42	NC	NC	Q16	9D
43	Q4	Q8	Q8	11B
44	D4	D8	D8	11C
45	NC	NC	D17	9B
46	NC	NC	Q17	10B
47		CQ		11A
48	Α	VSS	VSS	10A
49		Α		9A
50		Α		8B
51		Α		7C
52		Α		6C
53		R#		8A
54	NC	NC	BW1#	7A
55	BW0#			7B
56		K		6B
57		K#		6A
58	NC	NC	BW3#	5B
59	NC	BW1#	BW2#	5A
60		W#		4A
61		Α		5C
62		Α		4B
63	A A NC		3A	
64	VSS			2A
65	CQ#			1A
66	NC Q9 Q18		2B	
67	NC	D9	D18	3B
68	NC	NC	D27	1C
69	NC	NC	Q27	1B
70	NC	Q10	Q19	3D
71	NC	D10	D19	3C
72	NC	NC	D28	1D

Bit no.         Signal name no.         Bump no.         x9         x18         x36         ID           73         NC         NC         Q28         2C           74         Q5         Q11         Q20         3E           75         D5         D11         D20         2D           76         NC         NC         D29         2E           77         NC         NC         Q29         1E           78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         D30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         85         NC         NC         Q31         1J           85         NC         NC         Q31         2J         3K           86         NC         NC         Q31         2J           87         NC         NC         Q32	•				1
73         NC         NC         Q28         2C           74         Q5         Q11         Q20         3E           75         D5         D11         D20         2D           76         NC         NC         D29         2E           77         NC         NC         Q29         1E           78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         1H         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         Q32         1K     <	Bit	Signal name			Bump
74         Q5         Q11         Q20         3E           75         D5         D11         D20         2D           76         NC         NC         D29         2E           77         NC         NC         Q29         1E           78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         1H         1H           85         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L	no.	х9	x18	x36	ID
75         D5         D11         D20         2D           76         NC         NC         D29         2E           77         NC         NC         Q29         1E           78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         1H         1H           85         NC         NC         D31         1J         1H         1H	73	NC	NC	Q28	2C
76         NC         NC         D29         2E           77         NC         NC         Q29         1E           78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           95         NC	74	Q5	Q11	Q20	3E
77         NC         NC         Q29         1E           78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L	75	D5	D11	D20	2D
78         NC         Q12         Q21         2F           79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H         85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         Q33         1L           95         NC	76	NC	NC	D29	2E
79         NC         D12         D21         3F           80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97	77	NC	NC	Q29	1E
80         NC         NC         D30         1G           81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97	78	NC	Q12	Q21	2F
81         NC         NC         Q30         1F           82         Q6         Q13         Q22         3G           83         D6         D13         D22         2G           84         DLL#         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         D33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98	79	NC	D12	D21	3F
82       Q6       Q13       Q22       3G         83       D6       D13       D22       2G         84       DLL#       1H         85       NC       NC       D31       1J         86       NC       NC       Q31       2J         87       NC       Q14       Q23       3K         88       NC       D14       D23       3J         89       NC       NC       D32       2K         90       NC       NC       Q32       1K         91       Q7       Q15       Q24       2L         92       D7       D15       D24       3L         93       NC       NC       D33       1M         94       NC       NC       D33       1L         95       NC       Q16       Q25       3N         96       NC       D16       D25       3M         97       NC       NC       D34       1N         98       NC       NC       D34       2M         99       Q8       Q17       Q26       3P         100       D8       D17       D26 </td <td>80</td> <td>NC</td> <td>NC</td> <td>D30</td> <td>1G</td>	80	NC	NC	D30	1G
83         D6         D13         D22         2G           84         DLL#         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         D33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         D34         2M           99         Q8         Q17         Q26         3P           100	81	NC	NC	Q30	1F
84         DLL#         1H           85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         D33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100	82	Q6	Q13	Q22	3G
85         NC         NC         D31         1J           86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N     <	83	D6	D13	D22	2G
86         NC         NC         Q31         2J           87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         D34         1N           98         NC         NC         D34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         Q35         1P	84		DLL#		1H
87         NC         Q14         Q23         3K           88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         Q35         1P           102         NC         NC         Q35         1P	85	NC	NC	D31	1J
88         NC         D14         D23         3J           89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         Q35         1P           102         NC         NC         Q35         1P           103         A         3R           104	86	NC	NC	Q31	2J
89         NC         NC         D32         2K           90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	87	NC	Q14	Q23	3K
90         NC         NC         Q32         1K           91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	88	NC	D14	D23	3J
91         Q7         Q15         Q24         2L           92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	89	NC	NC	D32	2K
92         D7         D15         D24         3L           93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	90	NC	NC	Q32	1K
93         NC         NC         D33         1M           94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	91	Q7	Q15	Q24	2L
94         NC         NC         Q33         1L           95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	92	D7	D15	D24	3L
95         NC         Q16         Q25         3N           96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	93	NC	NC	D33	1M
96         NC         D16         D25         3M           97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	94	NC	NC	Q33	1L
97         NC         NC         D34         1N           98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	95	NC	Q16	Q25	3N
98         NC         NC         Q34         2M           99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	96	NC	D16	D25	ЗМ
99         Q8         Q17         Q26         3P           100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	97	NC	NC	D34	1N
100         D8         D17         D26         2N           101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	98	NC	NC	Q34	2M
101         NC         NC         D35         2P           102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	99	Q8	Q17	Q26	3P
102         NC         NC         Q35         1P           103         A         3R           104         A         4R           105         A         4P           106         A         5P	100	D8	D17	D26	2N
103       A       3R         104       A       4R         105       A       4P         106       A       5P	101	NC	NC	D35	2P
104       A       4R         105       A       4P         106       A       5P	102	NC	NC	Q35	1P
105 A 4P 106 A 5P	103	<u> </u>			3R
106 A 5P	104	А			4R
	105	А			4P
107 A 5N	106	А			5P
<b>.</b>	107	Α			5N
108 A 5R	108	А			5R
109 – Internal	109				Internal

**Remarks** Bump ID 10A of bit no. 48 can also be used as NC if the product is x18 or x36.

Bump ID 2A of bit no. 64 can also be used as NC.

The register always indicates LOW, however.

#### **JTAG Instructions**

Instructions	Description
EXTEST	The EXTEST instruction allows circuitry external to the component package to be tested. Boundary-scan register cells at output pins are used to apply test vectors, while those at input pins capture test results. Typically, the first test vector to be applied using the EXTEST instruction will be shifted into the boundary scan register using the PRELOAD instruction. Thus, during the update-IR state of EXTEST, the output drive is turned on and the PRELOAD data is driven onto the output pins.
IDCODE	The IDCODE instruction causes the ID ROM to be loaded into the ID register when the controller is in capture-DR mode and places the ID register between the TDI and TDO pins in shift-DR mode. The IDCODE instruction is the default instruction loaded in at power up and any time the controller is placed in the test-logic-reset state.
BYPASS	When the BYPASS instruction is loaded in the instruction register, the bypass register is placed between TDI and TDO. This occurs when the TAP controller is moved to the shift-DR state. This allows the board level scan path to be shortened to facilitate testing of other devices in the scan path.
SAMPLE / PRELOAD	SAMPLE / PRELOAD is a Standard 1149.1 mandatory public instruction. When the SAMPLE / PRELOAD instruction is loaded in the instruction register, moving the TAP controller into the capture-DR state loads the data in the RAMs input and Q pins into the boundary scan register. Because the RAM clock(s) are independent from the TAP clock (TCK) it is possible for the TAP to attempt to capture the I/O ring contents while the input buffers are in transition (i.e., in a metastable state). Although allowing the TAP to sample metastable input will not harm the device, repeatable results cannot be expected. RAM input signals must be stabilized for long enough to meet the TAPs input data capture setup plus hold time (tCS plus tCH). The RAMs clock inputs need not be paused for any other TAP operation except capturing the I/O ring contents into the boundary scan register. Moving the controller to shift-DR state then places the boundary scan register between the TDI and TDO pins.
SAMPLE-Z	If the SAMPLE-Z instruction is loaded in the instruction register, all RAM Q pins are forced to an inactive drive state (high impedance) and the boundary register is connected between TDI and TDO when the TAP controller is moved to the shift-DR state.

## **JTAG Instruction Coding**

IR2	IR1	IR0	Instruction	Note
0	0	0	EXTEST	
0	0	1	IDCODE	
0	1	0	SAMPLE-Z	1
0	1	1	RESERVED	2
1	0	0	SAMPLE / PRELOAD	
1	0	1	RESERVED	2
1	1	0	RESERVED	2
1	1	1	BYPASS	

**Notes 1.** TRISTATE all Q pins and CAPTURE the pad values into a SERIAL SCAN LATCH.

2. Do not use this instruction code because the vendor uses it to evaluate this product.

#### Output Pin States of CQ, CQ# and Q

Instructions	Control-Register Status	Output Pin Status	
		CQ,CQ#	Q
EXTEST	0	Update	High-Z
	1	Update	Update
IDCODE	0	SRAM	SRAM
	1	SRAM	SRAM
SAMPLE-Z	0	High-Z	High-Z
	1	High-Z	High-Z
SAMPLE	0	SRAM	SRAM
	1	SRAM	SRAM
BYPASS	0	SRAM	SRAM
	1	SRAM	SRAM

**Remark** The output pin statuses during each instruction vary according to the Control-Register status (value of Boundary Scan Register, bit no. 109).

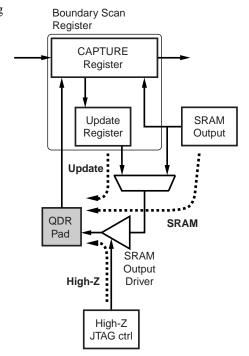
There are three statuses:

Update: Contents of the "Update Register" are output to the output pin (QDR Pad).

SRAM : Contents of the SRAM internal output "SRAM Output" are output to the output pin (QDR Pad).

High-Z: The output pin (QDR Pad) becomes high impedance by controlling of the "High-Z JTAG ctrl".

The Control-Register status is set during Update-DR at the EXTEST or SAMPLE instruction.



#### Boundary Scan Register Status of Output Pins CQ, CQ# and Q

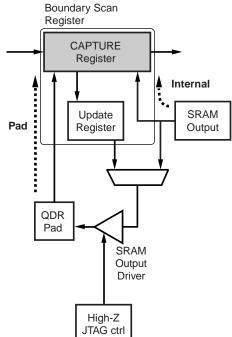
Instructions	SRAM Status	Boundary Scan Register Status		Note
		CQ,CQ#	Q	
EXTEST	READ (Low-Z)	Pad	Pad	
	NOP (High-Z)	Pad	Pad	
IDCODE	READ (Low-Z)	_	_	No definition
	NOP (High-Z)	_	_	
SAMPLE-Z	READ (Low-Z)	Pad	Pad	
	NOP (High-Z)	Pad	Pad	
SAMPLE	READ (Low-Z)	Internal	Internal	
	NOP (High-Z)	Internal	Pad	
BYPASS	READ (Low-Z)	_	_	No definition
	NOP (High-Z)	_	_	

**Remark** The Boundary Scan Register statuses during execution each instruction vary according to the instruction code and SRAM operation mode.

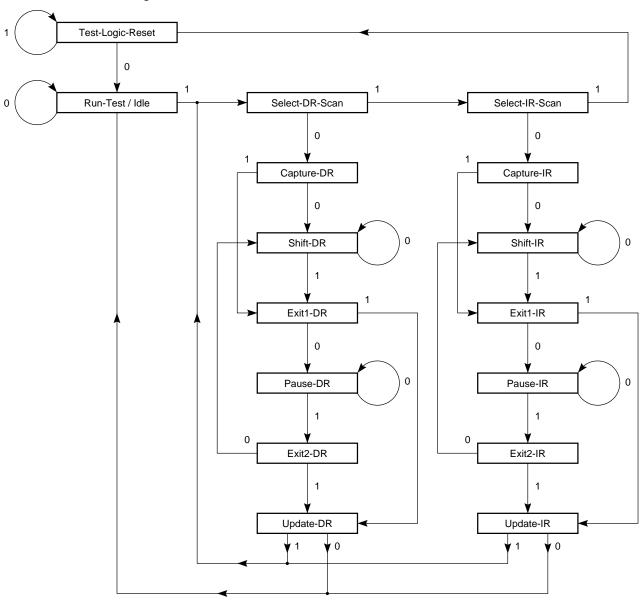
There are two statuses:

Pad : Contents of the output pin (QDR Pad) are captured in the "CAPTURE Register" in the Boundary Scan Register.

Internal: Contents of the SRAM internal output "SRAM Output" are captured in the "CAPTURE Register" in the Boundary Scan Register.

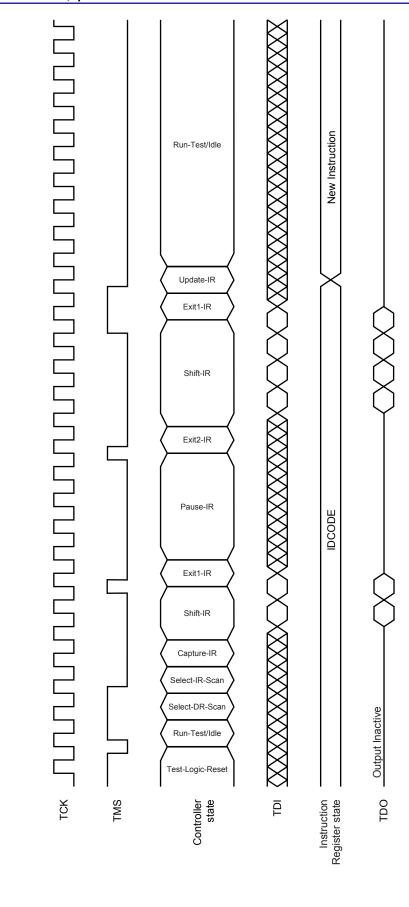


#### **TAP Controller State Diagram**

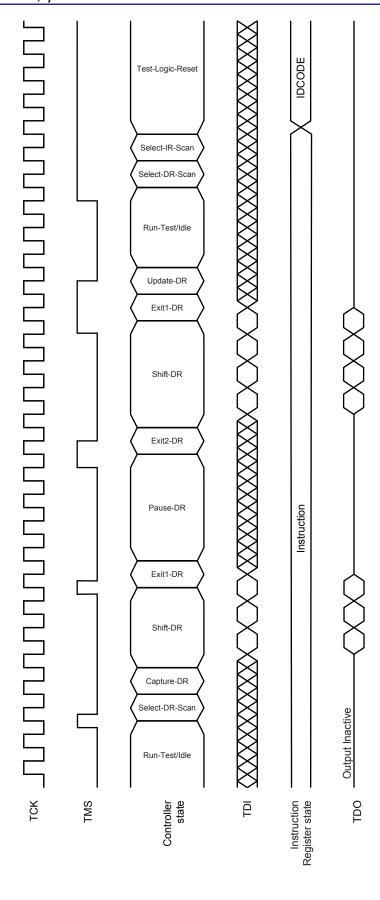


### **Disabling the Test Access Port**

It is possible to use this device without utilizing the TAP. To disable the TAP Controller without interfering with normal operation of the device, TCK must be tied to  $V_{SS}$  to preclude mid level inputs. TDI and TMS may be left open but fix them to  $V_{DD}$  via a resistor of about 1 k $\Omega$  when the TAP controller is not used. TDO should be left unconnected also when the TAP controller is not used.

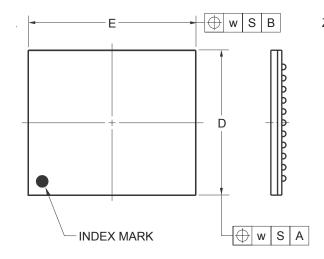


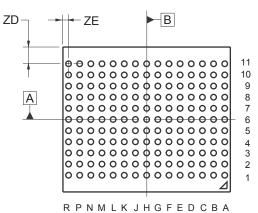
Test Logic Operation (Instruction Scan)

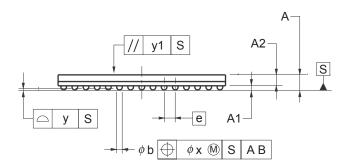


## **Package Dimensions**

## 165-PIN PLASTIC BGA(13x15)







	(UNIT:mm)
ITEM	DIMENSIONS
D	13.00±0.10
Е	15.00±0.10
W	0.30
Α	1.35±0.11
A1	0.37±0.05
A2	0.98
е	1.00
b	0.50+0.10
х	0.10
У	0.15
y1	0.25
ZD	1.50
ZE	0.50
	T165F1-100-EQ1

## **Recommended Soldering Condition**

Please consult with our sales offices for soldering conditions of these products.

## **Types of Surface Mount Devices**

μPD46365092BF1-EQ1 : 165-pin PLASTIC BGA (13 x 15) μPD46365182BF1-EQ1 : 165-pin PLASTIC BGA (13 x 15) μPD46365362BF1-EQ1 : 165-pin PLASTIC BGA (13 x 15)

## **Quality Grade**

- A quality grade of the products is "Standard".
- Anti-radioactive design is not implemented in the products.
- Semiconductor devices have the possibility of unexpected defects by affection of cosmic ray that reach to the ground and so forth.

**Revision History** 

## $\mu$ PD46365092B, $\mu$ PD46365182B, $\mu$ PD46365362B

Day	Data		Description		
Rev. Date		Page	Summary		
Rev.1.00	'11.05.18	- New Data Sheet			
Rev.2.00	'11.08.09	P9	Add comments for Power on Sequence (4 Times NOP)		
Rev.2.01	'12.05.21	P9 Modified comments for Power on Sequence			
		P3,4,5,6,14,32	Corrected typo.		
Rev.3.00	'12.07.13	ALL	Addition : E**Y series		
Rev.4.00	'12.11.09	ALL	Addition : -E33,-E33Y series, Lead series		
			Deletion : -E50,-E50Y series		

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